

High Voltage Switching Diode

MMSD103T1G, SMMSD103T1G

Features

- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	250	V
Peak Forward Current	IF	200	mA
Peak Forward Surge Current	I _{FM(surge)}	625	mA

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Forward Power Dissipation, FR–5 Board (Note 1) @ T _A = 25°C Derate above 25°C	P _F	400 3.2	mW mW/°C
Thermal Resistance, Junction-to-Case	$R_{ heta JL}$	174	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	492	°C/W
Junction and Storage Temperature Range	T _{J,} T _{stg}	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.



SOD-123 CASE 425 STYLE 1



MARKING DIAGRAM



JS = Device Code

M = Date Code

Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MMSD103T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SMMSD103T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

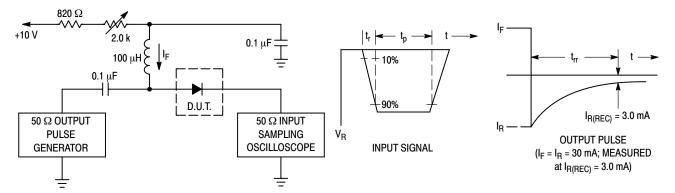
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^{*}For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MMSD103T1G, SMMSD103T1G

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Reverse Voltage Leakage Current $(V_R = 200 \text{ V})$ $(V_R = 200 \text{ V}, T_J = 150^{\circ}\text{C})$	I _R	- -	1.0 100	μΑ
Reverse Breakdown Voltage ($I_{BR} = 100 \ \mu A$)	V _(BR)	250	-	V
Forward Voltage (I _F = 100 mA) (I _F = 200 mA)	V _F	-	1000 1250	mV
Diode Capacitance (V _R = 0, f = 1.0 MHz)	C _D	-	5.0	pF
Reverse Recovery Time (I _F = I _R = 30 mA, R _L = 100 Ω)	t _{rr}	-	50	ns



Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (IF) of 30 mA.

2. Input pulse is adjusted so $I_{R(peak)}$ is equal to 30 mA.

 $3.\ t_p \ \text{"}\ t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit

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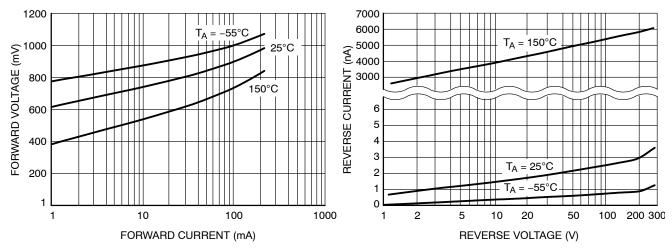


Figure 2. Forward Voltage

Figure 3. Reverse Leakage

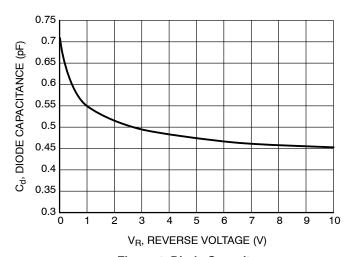


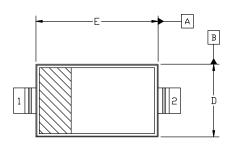
Figure 4. Diode Capacitance



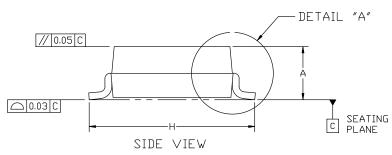


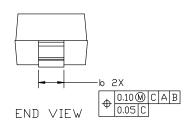
SOD-123 2-LEAD, 1.60x2.69x1.16 CASE 425 ISSUE H

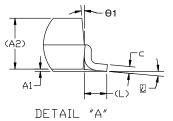
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TOP VIEW



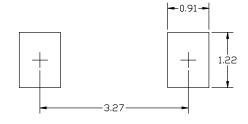




NOTES:

- . DIMENSION AND TOLERANCING PER ASME Y14.5M, 2018
- 2. CONTROLLING DIMENSION: MILLIMETERS

	MILLIMETER			
DIM	MIN.	N□M.	MAX.	
А	0.94	1.17	1.35	
A1	0.00	0.05	0.10	
A2	1.16 REF.			
b	0.51	0.61	0.71	
C	_	_	0.15	
D	1.40	1.60	1.80	
E	2.54	2.69	2.84	
Н	3.56	3.68	3,86	
L	0.25 REF.			
S	0°		10°	
θ1	0°		10°	



RECOMMENDED MOUNTING FOOTPRINT *For additional information on or Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference manual SDLDERRM/D.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1: PIN 1. CATHODE

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DESCRIPTION:	SOD-123 2-LEAD, 1.60x2.69x1.16		PAGE 1 OF 1	

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